Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My res	idence	e, pos	t off	ice a	ddre	ss an	ıd citiz	zenshi	ip are	as stat	ed bel	ow 1	next	to r	ny i	ame	€.						
										_								 	. .	 			

the specification				
	of which is attached hereto unless the foll	owing is checked:		
	was filed on	as Unite	ed States Application Number or	PCT International
	Application Number			
<u> </u>	(if applicable).			
	at I have reviewed and understand the con- ent referred to above.	ents of the above-identified	I specification, including the clair	m(s), as amended
I acknowledge th	e duty to disclose information which is ma	terial to patentability as defi-	ned in Title 37, Code of Federal R	tegulations, § 1.56.
inventor's certif	oreign priority benefits under Title 35, Unicate listed below and have also identified hat of the application on which priority is	below any foreign applicati claimed:	on for patent or inventor's certific	cate having a fil- Priority Claimed
(List prior	HEI.11 - 370328 (Number)	Japan (Country)	27/12/1999 (Day/Month/Year Filed)	Xi Yes D No
foreign applications.	(Number)	(Country)		_ Q Yes Q No
See note A	(Number)	(Country)	(Day/Month/Year Filed)	_ Q Yes Q No
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B on	pack of this page)	hed list for additional prior	foreign applications	
I hereby claim t	he benefit under Title 35, United States Co	···		listed below.
I hereby claim t	he benefit under Title 35, United States Co (Application Number	···	States provisional application(s) (Filing Date)	listed below.
I hereby claim t		er)		listed below.
I hereby claim t subject matter o the first paragra ity as defined in	(Application Number	er) ode, § 120 of any United State of disclosed in the prior United I acknowledge the duty to control of the c	(Filing Date) (Filing Date) ates application(s) listed below are listed States application in the mare listelose information which is mat	— nd, insofar as the nner provided by erial to patentabil-
I hereby claim t subject matter o the first paragra ity as defined in	(Application Number (Application Number))	er) ode, § 120 of any United State of disclosed in the prior United I acknowledge the duty to control of the c	(Filing Date) (Filing Date) ates application(s) listed below are listed States application in the mare listelose information which is mat	nd, insofar as the nner provided by erial to patentabil- rior application

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

James E. Armstrong, III, Reg. No. 18,366; William F. Westerman, Reg. No. 29,988; Ken-Ichi Hattori, Reg. No. 32,861; Le-Nhung McLeland, Reg. No. 31,541; Ronald F. Naughton, Reg. No. 24,616; John R. Pegan, Reg. No. 18,069; William G. Kratz, Jr., Reg. No. 22,631; Albert Tockman, Reg. No. 19,722; Mel R. Quintos, Reg. No. 31,898; Donald W. Hanson, Reg. No. 27,133; Stephen G. Adrian, Reg. No. 32,878; William L. Brooks, Reg. No. 34,129; John F. Carney, Reg. No. 20,276; Edward F. Welsh, Reg. No. 22,455; Patrick D. Muir, Reg. No. 37,403; Gay A. Spahn, Reg. No. 34,978; John P. Kong, Reg. No. 40,054; and Luke A. Kilyk, Reg. No. 33,251.

Please direct all communications to the following address:

ARMSTRONG, WESTERMAN, HATTORI, McLELAND & NAUGHT 1725 K Street, N.W., Suite

Washington, D.C. 20006

Telephone: (202) 659-2930 Fax: (202) 887-0357

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Full name of sole or first inventor (given name, family name)	Matsuyui	ki waisumoto	
(See note	Inventor's Signature <u>Katsuyuki Matsumo</u> 7	Date	11/17	/2000
C above)	Residence Hirakata - shi, Osaka, Japan			
	Post Office Address 5 - 25 - 46, Nagaomotomachi			
	Tost Office Address			
Full name of s	second inventor (given name, family name)			
Inventor's Sig	gnature	Date		
Residence		Citizenship		
Post Office Ad	ddress		 	
Full name of t	third inventor (given name, family name)		***	
Inventor's Sig	gnature	Date		
18 8				
Ţ,	ddress			
	fourth inventor (given name, family name)			
- Table 1	gnature			
_				
Post Office A	ddress			
	fifth inventor (given name, family name)			
ā \$	gnature			
Residence		Citizenship		
Post Office A	ddress			
Full name of	sixth inventor (given name, family name)			
Inventor's Sig	gnature	Date		
Residence		Citizenship		
Post Office A	ddress			
Full name of	seventh inventor (given name, family name)			
Inventor's Sig	gnature	Date		
Residence		Citizenship		
Post Office A	Address			
Full name of	eighth inventor (given name, family name)			
Inventor's Sig	gnature	Date	•	
	Address	-		